PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Yasumasa HIROO	03/29/2013
Yoichi KOBAYASHI	03/29/2013
Katsutoshi ONO	03/29/2013

RECEIVING PARTY DATA

Name:	Ebara Corporation	
Street Address:	11-1, Haneda Asahi-cho, Ohta-ku	
City:	Tokyo	
State/Country:	JAPAN	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13859496

CORRESPONDENCE DATA

Fax Number: 2155683439

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ATTORNEY DOCKET NUMBER:	EBMZ-0004
NAME OF SUBMITTER:	Laura Rae Workman
Signature:	/Laura Rae Workman/
Date:	05/17/2013
	PATENT

502352288 REEL: 030444 FRAME: 0990

13859496

CH \$40,00

Total Attachments: 6

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> PATENT REEL: 030444 FRAME: 0991

DOCKET NO.: EBMZ-0004

ASSIGNMENT

WHEREAS, I, Yasumasa HIROO citizen of Japan, residing at c/o Ebara Corporation, 11-1, Haneda Asahi-cho, Ohta-ku, Tokyo, Japan, ASSIGNOR, am an inventor of one or more inventions disclosed, described and/or claimed in the application referred to as Docket Number ("the invention"), which is entitled "POLISHING APPARATUS AND POLISHING METHOD" ("the subject application"), and which claims priority to Japanese patent application number 2012-89585 filed April 10, 2012 ("the priority application"). I authorize and direct any of the attorneys responsible for prosecuting the subject application on behalf of the ASSIGNEE to insert the application number and filing date of the subject application in the final paragraph of this assignment.

AND WHEREAS, EBARA CORPORATION, ASSIGNEE, having a place of business at 11-1, Haneda Asahi-cho, Ohta-ku, Tokyo, Japan, is desirous of obtaining my entire right, title, and interest in, to, and under the invention:

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, I, the ASSIGNOR, hereby sell, assign, transfer, and set over, unto the ASSIGNEE, its successors, legal representatives, and assigns, my entire right, title, and interest in, to, and under the invention, and all applications for industrial property protection, including without limitation, all applications for patents, utility models, inventors' certificates, and designs that have been filed, and that may hereafter be filed, in any country, that disclose, describe, and/or claim the invention, including, without limitation, the subject application and the priority application, and all extensions, renewals, and reissues of such applications, including all divisions and continuations in whole or in part; all patents granted on such applications in any country, and all extensions, renewals, and reissues of such patents, including all divisions and continuations in whole or in part; the right to file such applications in any country; and the right to claim for such applications in any country the priority rights derived from the priority application and the subject application under the International Convention for the Protection of Industrial Property, the Patent Laws of the United States, any other international agreement or protection, or the domestic laws of any country in which any such application is filed, as may be applicable.

AND I HEREBY covenant and agree that I have full right to convey my entire interest herein assigned, and that I have not executed, and will not execute, any agreement in conflict herewith.

AND I HEREBY further covenant and agree that I will communicate to the ASSIGNEE, its successors, legal representatives, and assigns, any facts known to me respecting the invention, and testify in any legal proceeding, sign all lawful papers, execute all disclaimers and all divisional, continuing, reissue, and foreign applications, make all rightful oaths, deliver upon request all papers, documents, affidavits, or other instruments that may be necessary or helpful in the prosecution of any application for industrial property protection describing and/or claiming the invention, and generally do everything possible to aid the ASSIGNEE, its successors, legal

/Michael J. Swope/

Name of Attorney: Michael J. Swope

Registration No.: 38,041

The foregoing assignment covers patent application number 13/859496 , filed on

April 9, 2013

Date of Insertion: April 19, 2013

DOCKET NO.: EBMZ-0004

ASSIGNMENT

WHEREAS, I, Yoichi KOBAYASHI citizen of Japan, residing at c/o Ebara Corporation, 11-1, Haneda Asahi-cho, Ohta-ku, Tokyo, Japan, ASSIGNOR, am an inventor of one or more inventions disclosed, described and/or claimed in the application referred to as Docket Number ("the invention"), which is entitled "POLISHING APPARATUS AND POLISHING METHOD" ("the subject application"), and which claims priority to Japanese patent application number 2012-89585 filed April 10, 2012 ("the priority application"). I authorize and direct any of the attorneys responsible for prosecuting the subject application on behalf of the ASSIGNEE to insert the application number and filing date of the subject application in the final paragraph of this assignment.

AND WHEREAS, EBARA CORPORATION, ASSIGNEE, having a place of business at 11-1, Haneda Asahi-cho, Ohta-ku, Tokyo, Japan, is desirous of obtaining my entire right, title, and interest in, to, and under the invention:

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, I, the ASSIGNOR, hereby sell, assign, transfer, and set over, unto the ASSIGNEE, its successors, legal representatives, and assigns, my entire right, title, and interest in, to, and under the invention, and all applications for industrial property protection, including without limitation, all applications for patents, utility models, inventors' certificates, and designs that have been filed, and that may hereafter be filed, in any country, that disclose, describe, and/or claim the invention, including, without limitation, the subject application and the priority application, and all extensions, renewals, and reissues of such applications, including all divisions and continuations in whole or in part; all patents granted on such applications in any country, and all extensions, renewals, and reissues of such patents, including all divisions and continuations in whole or in part; the right to file such applications in any country; and the right to claim for such applications in any country the priority rights derived from the priority application and the subject application under the International Convention for the Protection of Industrial Property, the Patent Laws of the United States, any other international agreement or protection, or the domestic laws of any country in which any such application is filed, as may be applicable.

AND I HEREBY covenant and agree that I have full right to convey my entire interest herein assigned, and that I have not executed, and will not execute, any agreement in conflict herewith.

AND I HEREBY further covenant and agree that I will communicate to the ASSIGNEE, its successors, legal representatives, and assigns, any facts known to me respecting the invention, and testify in any legal proceeding, sign all lawful papers, execute all disclaimers and all divisional, continuing, reissue, and foreign applications, make all rightful oaths, deliver upon request all papers, documents, affidavits, or other instruments that may be necessary or helpful in the prosecution of any application for industrial property protection describing and/or claiming the invention, and generally do everything possible to aid the ASSIGNEE, its successors, legal

DOCKET NO.: EBMZ-0004
representatives, and assigns, to obtain and enforce proper protection for the invention in all countries.
IN TESTIMONY WHEREOF, I have signed my name below on the date indicated above my signature.
Executed thisday of, year of, year of
Joid Kolayasi Signature (Yoichi KOBAYASHI) ************************************
STATEMENT OF WITNESS SIGNED at
(City) (Country)
This, 201
I, whose full
residence address is
was personally present and did see execute the above assignment on the day of, 201, and such assignor is personally known to me to be the person described in such document.
Signature of Witness

The foregoing assignment covers patent application number 13/859496 , filed on

/Michael J. Swope/

Name of Attorney: Michael J. Swope

Registration No.: 38,041

April 9, 2013

Date of Insertion: April 19, 2013

DOCKET NO.: EBMZ-0004

ASSIGNMENT

WHEREAS, I, Katsutoshi ONO citizen of Japan, residing at c/o Ebara Corporation, 11-1, Haneda Asahi-cho, Ohta-ku, Tokyo, Japan, ASSIGNOR, am an inventor of one or more inventions disclosed, described and/or claimed in the application referred to as Docket Number ("the invention"), which is entitled "POLISHING APPARATUS AND POLISHING METHOD" ("the subject application"), and which claims priority to Japanese patent application number 2012-89585 filed April 10, 2012 ("the priority application"). I authorize and direct any of the attorneys responsible for prosecuting the subject application on behalf of the ASSIGNEE to insert the application number and filing date of the subject application in the final paragraph of this assignment.

AND WHEREAS, EBARA CORPORATION, ASSIGNEE, having a place of business at 11-1, Haneda Asahi-cho, Ohta-ku, Tokyo, Japan, is desirous of obtaining my entire right, title, and interest in, to, and under the invention:

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, I, the ASSIGNOR, hereby sell, assign, transfer, and set over, unto the ASSIGNEE, its successors, legal representatives, and assigns, my entire right, title, and interest in, to, and under the invention, and all applications for industrial property protection, including without limitation, all applications for patents, utility models, inventors' certificates, and designs that have been filed, and that may hereafter be filed, in any country, that disclose, describe, and/or claim the invention, including, without limitation, the subject application and the priority application, and all extensions, renewals, and reissues of such applications, including all divisions and continuations in whole or in part; all patents granted on such applications in any country, and all extensions, renewals, and reissues of such patents, including all divisions and continuations in whole or in part; the right to file such applications in any country; and the right to claim for such applications in any country the priority rights derived from the priority application and the subject application under the International Convention for the Protection of Industrial Property, the Patent Laws of the United States, any other international agreement or protection, or the domestic laws of any country in which any such application is filed, as may be applicable.

AND I HEREBY covenant and agree that I have full right to convey my entire interest herein assigned, and that I have not executed, and will not execute, any agreement in conflict herewith.

AND I HEREBY further covenant and agree that I will communicate to the ASSIGNEE, its successors, legal representatives, and assigns, any facts known to me respecting the invention, and testify in any legal proceeding, sign all lawful papers, execute all disclaimers and all divisional, continuing, reissue, and foreign applications, make all rightful oaths, deliver upon request all papers, documents, affidavits, or other instruments that may be necessary or helpful in the prosecution of any application for industrial property protection describing and/or claiming the invention, and generally do everything possible to aid the ASSIGNEE, its successors, legal

representatives, and assigns, to obtain and enforce proper protection for the invention in all countries.
IN TESTIMONY WHEREOF, I have signed my name below on the date indicated above my signature.
Executed this 29th day of March, year of 2013.
<u>Latsutohi Ono</u> Signature (Katsutoshi ONO) ***********************************
STATEMENT OF WITNESS SIGNED at
(City) (Country)
This day of, 201
I, whose full
residence address is
was personally present and did see execute the above assignment on the day of, 201, and such assignor is personally known to me to be the person described in such document.
Signature of Witness

The foregoing assignment covers patent application number 13/859,496 , filed on April 9, 2013 .
/Michael J. Swope/

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Name of Attorney: Michael J. Swope

Date of Insertion: April 19, 2013

Registration No.: 38,041

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